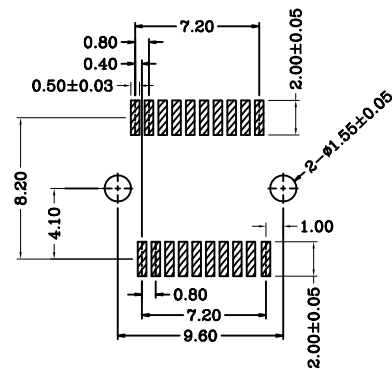
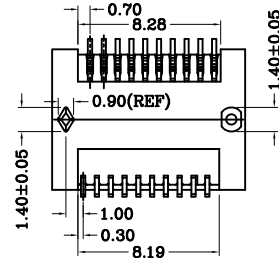
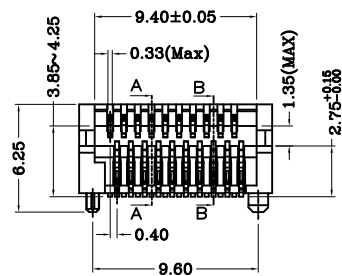
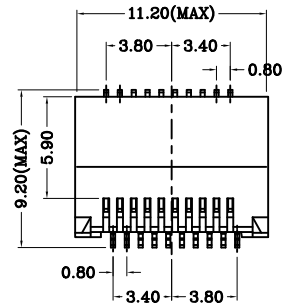
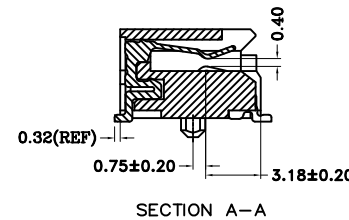
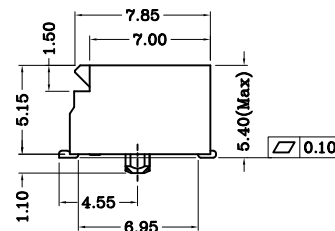
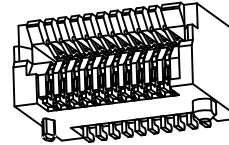


REV.	SPECIFICATION	ECN NO.	APPD.
R10		ECN220501	



P.C.Board Layout
(Tolerance=±0.05 Top View)



Material and Plating:

Housing: LCP, UL94V-0 , BLACK.

Signal Contacts : Phosphor Bronze.

30Au+Pd/Ni on Contact Area and 80u" Min Matte Tin Plated on Solder Tail over nickel 50u"Min .

Electrical Characteristics:

Current Rating: 0.5 A.

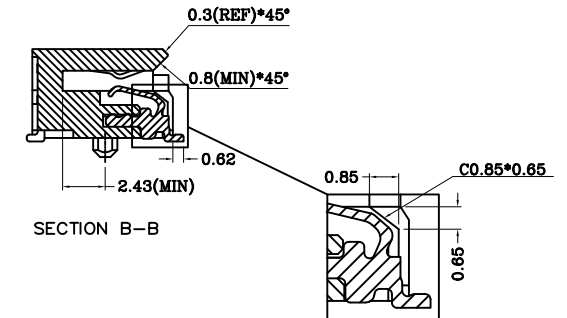
Dielectric Withstanding Voltage: 300V For 1 minute.

Insulation Resistance: 500MΩ min.

Contact Resistance: 35mΩ max.

Operating Temperature: -55°C~+85°C.

***RoHS Compliant**



Series: 8950-Z
Position: 20
CB: 30
D: 30μ"
P: 30μ"
T: 30μ"
T: Tape&Reel Packaging
P: With Post
D: SMD Type

Tolerances	Dwg.No.	8950-D0000-001
x = ±0.5	Projection	⊕ ⊖
.x = ±0.25	Unit	mm
.xx = ±0.15	Scale	1:1
	Drawn By	JL 04/21"22

Title:

8950 Series
SFP+ Connector 0.80mm (0.0315")

OUPIN

OUPIN ELECTRONIC(KUNSHAN) CO., LTD.

P/N: 8950-Z20CB30DPT

SHEET	1/1	Ver.No.	R10
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